

## CBR02C519C1GAC

CBR-SMD RF COG, Ceramic, 5.1 pF, +/-0.25 pF, 100 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Click here for the 3D model.

Dimensions	
Chip Size	0201
L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
Т	0.3mm +/-0.03mm
В	0.15mm +/-0.05mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	15000

CBR-SMD RF COG
SMD Chip
SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Ultra High Q, Low ESR, Class I
Yes
Tin
No
No
0.3 mg
Solder Wave or Solder Reflow.
78 Weeks
1

Specifications	
Capacitance	5.1 pF
Capacitance Tolerance	+/-0.25 pF
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms
Dissipation Factor	0.2%1MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	502

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